

Ultrafast Rectifier, 2 A FRED Pt®


SMB (DO-214AA)


FEATURES

- Ultrafast recovery time, reduced Q_{rr} and soft recovery
- 175 °C maximum operating junction temperature
- Specific for output and snubber operation
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 A
V_R	200 V
V_F at I_F	0.66 V
t_{rr} typ.	24 ns
T_J max.	175 °C
Package	SMB (DO-214AA)
Circuit configuration	Single

DESCRIPTION / APPLICATIONS

State of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop, ultrafast recovery time, and fast recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in snubber, output operation, inverters or as freewheeling diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element.

MECHANICAL DATA

Case: SMB (DO-214AA)

Molding compound meets UL 94 V-0 flammability rating Halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per J-STD-002

Polarity: color band denotes cathode end

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Peak repetitive reverse voltage	V_{RRM}		200	V
Average rectified forward current	$I_{F(AV)}$	$T_L = 150\text{ °C}^{(1)}$	2	A
Non-repetitive peak surge current	I_{FSM}	$T_J = 25\text{ °C}$, 6 ms square pulse	70	
Operating junction and storage temperatures	T_J, T_{Stg}		-65 to +175	°C

Note

⁽¹⁾ Mounted on PCB with 6 mm x 3.5 mm lands

ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ °C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V_{BR}, V_R	$I_R = 100\text{ }\mu\text{A}$	200	-	-	V
Forward voltage	V_F	$I_F = 2\text{ A}$	-	0.84	0.9	
		$I_F = 2\text{ A}, T_J = 150\text{ °C}$	-	0.66	0.7	
Reverse leakage current	I_R	$V_R = V_R$ rated	-	-	2	μA
		$T_J = 150\text{ °C}, V_R = V_R$ rated	-	-	20	
Junction capacitance	C_T	$V_R = 200\text{ V}$	-	12	-	pF
Critical rate of rise of reverse voltage	dV/dt_r		-	-	10 000	V/ μs

DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t_{rr}	$I_F = 1.0\text{ A}$, $dI_F/dt = 100\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$	-	24	-	ns
		$I_F = 1.0\text{ A}$, $dI_F/dt = 50\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$	-	27	-	
		$I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $I_{rr} = 0.25\text{ A}$	-	-	23	
		$T_J = 25\text{ }^{\circ}\text{C}$	-	21	-	
		$T_J = 125\text{ }^{\circ}\text{C}$	-	26	-	
Peak recovery current	I_{RRM}	$T_J = 25\text{ }^{\circ}\text{C}$	-	2.7	-	A
		$T_J = 125\text{ }^{\circ}\text{C}$	-	3.4	-	
Reverse recovery charge	Q_{rr}	$T_J = 25\text{ }^{\circ}\text{C}$	-	28	-	nC
		$T_J = 125\text{ }^{\circ}\text{C}$	-	43	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T_J, T_{Stg}		-65	-	175	$^{\circ}\text{C}$
Thermal resistance, junction to mount	$R_{thJM}^{(1)}$		-	-	17	$^{\circ}\text{C}/\text{W}$
Thermal resistance, junction to ambient	$R_{thJA}^{(1)}$		-	-	80	
Approximate Weight			0.1			g
			0.003			oz.
Marking device		Case style SMB (DO-214AA)	2H2			

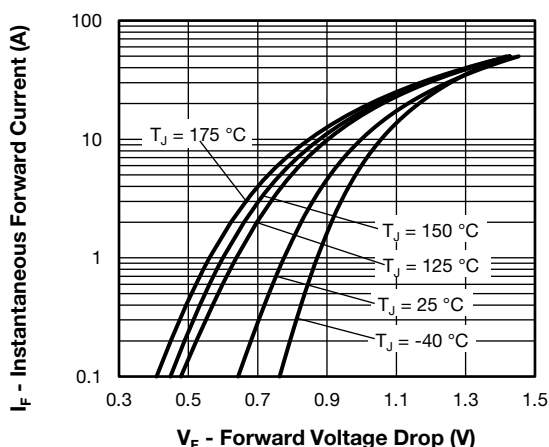
Note
⁽¹⁾ Units mounted on PCB 6 mm x 3.5 mm land areas


Fig. 1 - Typical Forward Voltage Drop Characteristics

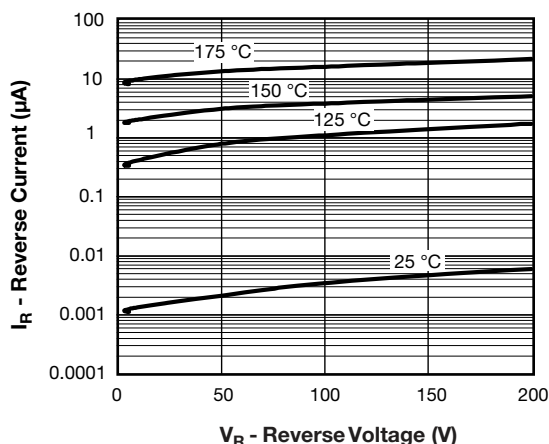


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

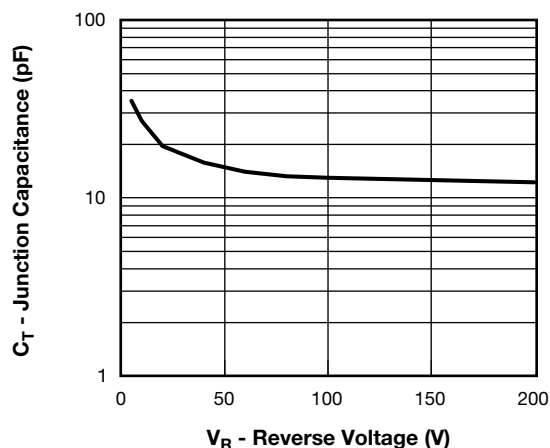


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

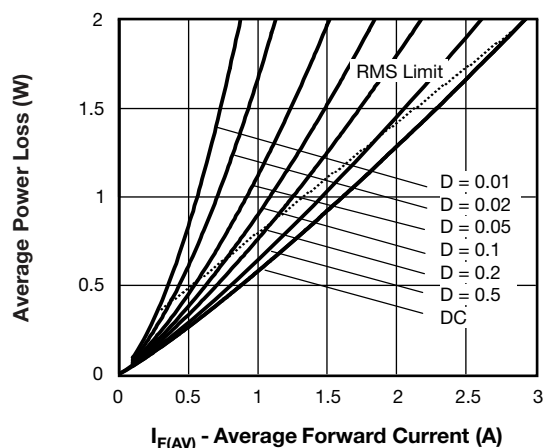


Fig. 5 - Forward Power Loss Characteristics

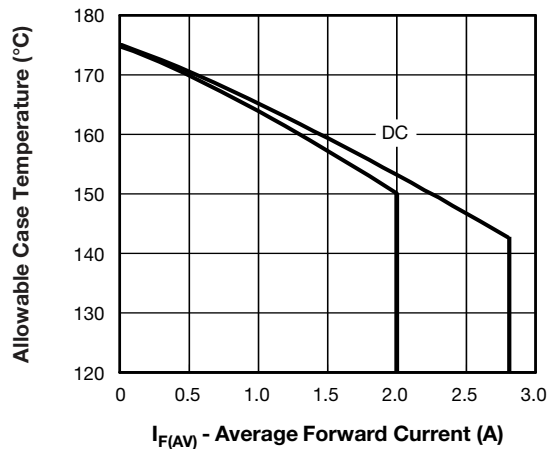
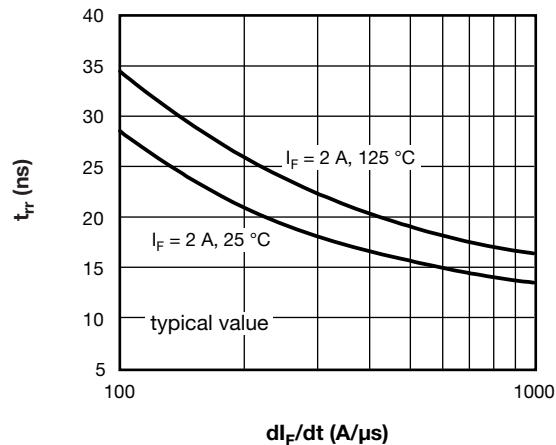
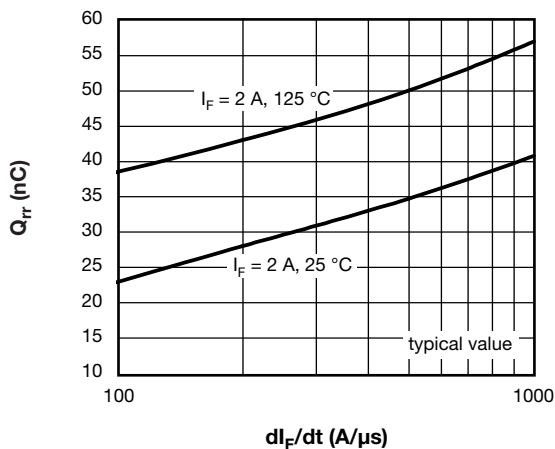


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current


Fig. 6 - Typical Reverse Recovery vs. dI_F/dt

Fig. 7 - Typical Stored Charge vs. dI_F/dt

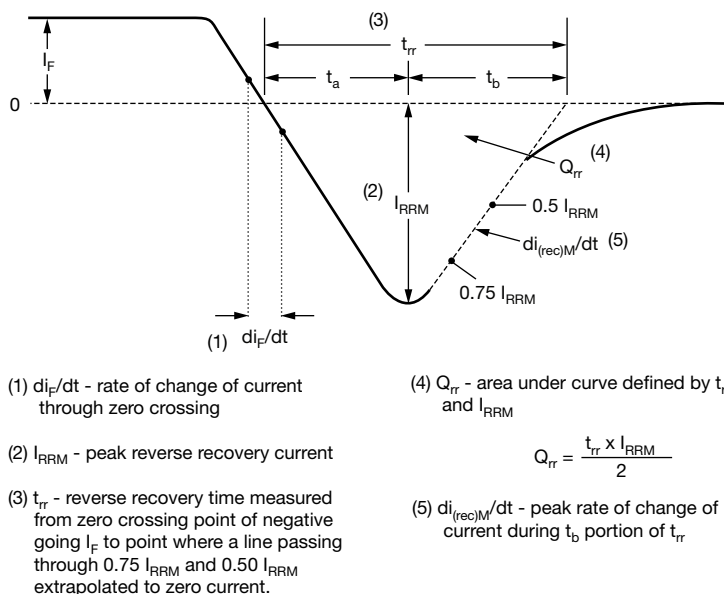


Fig. 8 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION (Example)

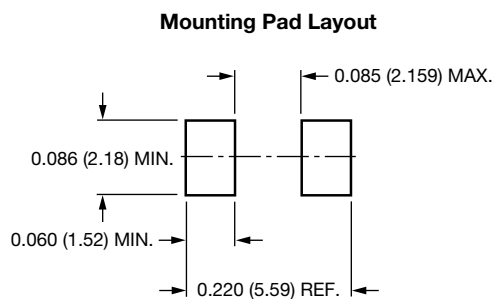
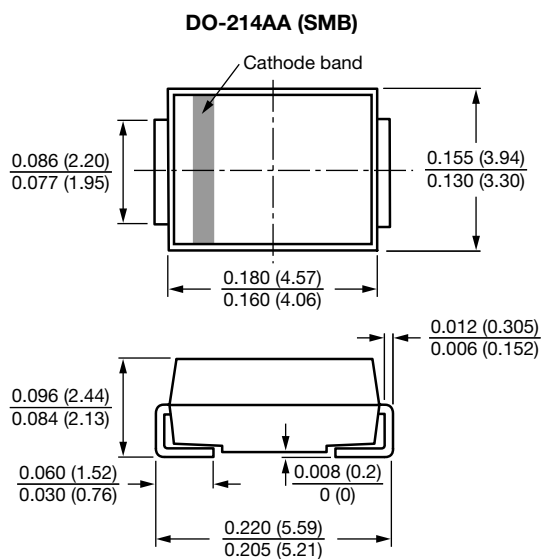
PREFERRED P/N	PACKAGE CODE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-2EGH02HM3_A/I	I	3200	13" diameter plastic tape and reel

LINKS TO RELATED DOCUMENTS

Dimensions	www.vishay.com/doc?95401
Part marking information	www.vishay.com/doc?95472
Packaging information	www.vishay.com/doc?95404
SPICE model	www.vishay.com/doc?96021

SMB

DIMENSIONS in inches (millimeters)





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